# High-voltage band switching diode **SS376**

# Applications

High voltage switching

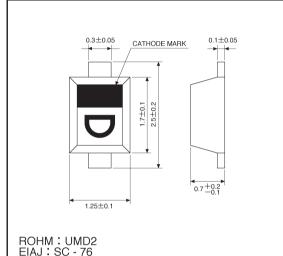
#### Features

- 1) High reliability.
- 2) Small surface mounting type. (UMD2)
- 3) Peak reverse voltage guaranteed at 300V with this size.

#### Construction

Silicon epitaxial planar

### External dimensions (Units: mm)



ROHM: UMD2 EIAJ: SC - 76 JEDEC: SOD - 323

# Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Peak reverse voltage	V <sub>RM</sub>	300	V
DC reverse voltage	VR	250	V
Peak forward current	Іғм	300	mA
Mean rectifying current	lo	100	mA
Surge current (10ms)	Isurge	2	А
Junction temperature	Tj	125	°C
Storage temperature	Tstg	<b>−55∼</b> +125	°C

## Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditons
Forward voltage	VF	_	0.97	1.2	V	I <sub>F</sub> =100mA
Reverse current	IR	_	0.03	0.2	μΑ	V <sub>R</sub> =250V
Reverse current	IR	_	_	100	μΑ	V <sub>R</sub> =300V
Capacitance between terminals	Ст	_	1.2	3	pF	V <sub>R</sub> =0V, f=1MHz
Reverse recovery time	trr	_	30	100	ns	I <sub>R</sub> =30mA I <sub>F</sub> =30mA Irr=3mA

Diodes 1SS376

# ●Electrical characteristic curves (Ta = 25°C unless specified otherwise)

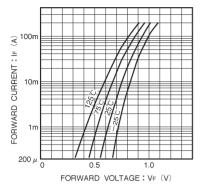


Fig. 1 Forward characteristics

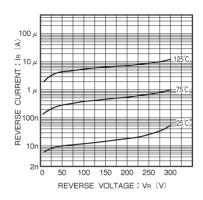


Fig. 2 Reverse characteristics

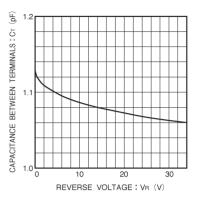


Fig. 3 Capacitance between terminals characteristics

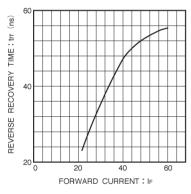


Fig. 4 Reverse recovery time characteristics

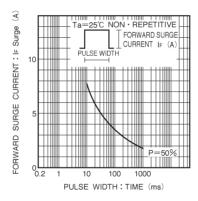


Fig. 5 Surge current characteristics

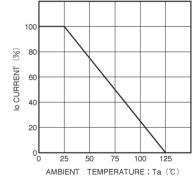


Fig. 6 Derating curve (mounting on glass epoxy PCBs)